Resistive Product Solutions

Features:

- 0402 to 2512 & 1225 sizes available
- Power ratings to 3W
- Low inductance less than 0.2nH typically
- RoHS compliant
- Non-standard resistance values available
- 2010 and 2512 sizes available with narrow terminations (CSRN)



Electrical Specifications									
Type / Code	Old Pkg Code	Power Rating (Watts) @ 70°C	Dielectric Withstanding	Resistance Temperature	Ohmic Range (Ω) and Tolerance				
			Voltage	Coefficient	1%	2%, 5%			
CSR0402	1/8S	0.125W	200V	±200 ppm/°C	0.051 - 1	0.051 - 1			
CSR0603	1/8	0.125W	200V	±300 ppm/°C	0.02 - 1	0.02 - 1			
CSR0805	1/4	0.25W	200V	±200 ppm/°C	0.02 - 1	0.02 - 1			
CSR1206	1/2	0.5W	200V	±100 ppm/°C (1)	0.01 - 1	0.01 - 1			
CSRN0815	18	1W	200V	±300 ppm/°C ±150 ppm/°C	0.01 - 0.019 0.02 - 0.5	0.01 - 0.019 0.02 - 0.5			
CSR2010	1	1W	200V	±100 ppm/°C (1)	0.01 - 1	0.01 - 1			
CSRN2010	1	1W	200V	±250 ppm/°C	0.01 - 1	0.01 - 1			
CSR2512	2	2W	200V	±200 ppm/°C	0.01 - 1	0.01 - 1			
CSRN2512	2	2W	200V	±200 ppm/°C	0.01 - 1	0.01 - 1			
CSR1225	3	3W	200V	±200 ppm/°C ±100 ppm/°C	0.003 - 0.02 0.021 - 10	0.003 - 0.02 0.021 - 10			

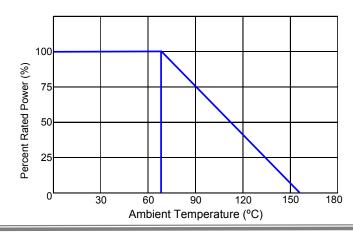
⁽¹⁾ Contact Factory for TCR below 50mOhm

Please refer to the High Power Resistor Application Note (page 4) for more information on designing and implementing high power resistor types.

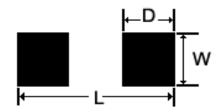
Performance Characteristics								
Test	Test Specification	Typical						
Moisture Resistance	± 0.5%	≤ 0.5%						
Load Life	± 0.5%	≤ 0.5%						
Leach Resistance	90 seconds minimum	> 90 seconds						
Resistance to Soldering Heat	± 0.5%	≤ 0.25%						
Solderability	minimum 95% coverage	≥ 95%						
Temperature Cycling	± 0.5%	≤ 0.5%						
Thermal Shock	± 0.5%	≤ 0.5%						
Short Time Overload	± 0.5%	≤ 0.5%						
Insulation Resistance	1MΩ minimum	≥ 1MΩ						

Operating Temperature Range: -55°C to +155°C

Power Derating Curve:

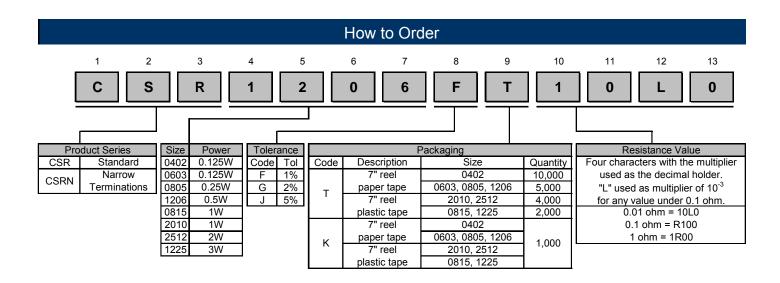


Mechanical Specifications										
Type / Code	L	W	Н	a	b	Unit				
	Body Length	Body Width	Body Height	Top Termination	Bottom Termination	O				
CSR0402	0.039 ± 0.002	0.020 ± 0.002	0.013 ± 0.004	0.010 ± 0.004	0.008 ± 0.004	inches				
C3R0402	1 ± 0.05	0.5 ± 0.05	0.32 ± 0.1	0.25 ± 0.1	0.2 ± 0.1	mm				
CSR0603	0.063 ± 0.004	0.032 ± 0.004	0.018 ± 0.004	0.012 ± 0.008	0.012 ± 0.008	inches				
03110003	1.6 ± 0.1	0.8 ± 0.1	0.45 ± 0.1	0.3 ± 0.2	0.3 ± 0.2	mm				
CSR0805	0.079 ± 0.006	0.049 ± 0.006	0.022 ± 0.004	0.012 ± 0.008	0.016 ± 0.010	inches				
CSK0003	2 ± 0.15	1.25 ± 0.15	0.55 ± 0.1	0.3 ± 0.2	0.4 ± 0.25	mm				
CSR1206	0.120 ± 0.006	0.061 ± 0.006	0.022 ± 0.004	0.020 ± 0.012	0.016 ± 0.010	inches				
C3K1200	3.05 ± 0.15	1.55 ± 0.15	0.55 ± 0.1	0.5 ± 0.3	0.4 ± 0.25	mm				
CSRN0815	0.079 ± 0.008	0.148 ± 0.008	0.024 ± 0.004	0.016 ± 0.008	0.016 ± 0.008	inches				
CSINIVOUTS	2 ± 0.2	3.75 ± 0.2	0.6 ± 0.1	0.4 ± 0.2	0.4 ± 0.2	mm				
CSR2010	0.197 ± 0.008	0.100 ± 0.008	0.020 ± 0.006	0.068 ± 0.006	0.067 ± 0.006	inches				
CSI\2010	5 ± 0.2	2.54 ± 0.2	0.5 ± 0.15	1.72 ± 0.15	1.7 ± 0.15	mm				
CSRN2010	0.197 ± 0.008	0.097 ± 0.006	0.024 ± 0.006	0.024 ± 0.012	0.020 ± 0.010	inches				
C31(142010	5 ± 0.2	2.45 ± 0.15	0.6 ± 0.15	0.6 ± 0.3	0.5 ± 0.25	mm				
CSR2512	0.252 ± 0.008	0.126 ± 0.008	0.020 ± 0.006	0.075 ± 0.006	0.075 ± 0.006	inches				
001(2012	6.4 ± 0.2	3.2 ± 0.2	0.5 ± 0.15	1.9 ± 0.15	1.9 ± 0.15	mm				
CSRN2512	0.250 ± 0.008	0.124 ± 0.006	0.024 ± 0.004	0.024 ± 0.012	0.022 ± 0.010	inches				
CORNZOIZ	6.35 ± 0.2	3.15 ± 0.15	0.6 ± 0.1	0.6 ± 0.3	0.55 ± 0.25	mm				
CSR1225	0.122 ± 0.006	0.248 ± 0.006	0.035 ± 0.006	0.024 ± 0.012	0.022 ± 0.010	inches				
G3R1225	3.1 ± 0.15	6.3 ± 0.15	0.9 ± 0.15	0.6 ± 0.3	0.55 ± 0.25	mm				



Solder Pad Dimensions								
Type / Code	L Total Length	W Total Width	D Pad Depth	Unit	CSR1225 4 Terminal Bottom			
CSR0402	0.059 1.50	0.024 0.60	0.020 0.50	inches mm	0.032"±0.005"			
CSR0603	0.094 2.40	0.039 1.00	0.031 0.80	inches mm	+ 0.020 ±0.005			
CSR0805	0.118 3.00	0.055 1.40	0.039 1.00	inches mm	0.250"±0.005" S			
CSR1206	0.169 4.30	0.067 1.70	0.055 1.40	inches mm	0.030"±0.005"			
CSRN0815	0.154 3.90	0.181 4.60	0.059 1.50	inches mm	0.125"±0.005"			
CSR2010	0.260 6.60	0.100 2.55	0.110 2.80	inches mm				
CSRN2010	0.252 6.40	0.098 2.50	0.055 1.40	inches mm				
CSR2512	0.315 8.00	0.126 3.20	0.110 2.80	inches mm				
CSRN2512	0.319 8.10	0.126 3.20	0.083 2.10	inches mm				
CSR1225	0.236 6.00	0.260 6.60	0.079 2.00	inches mm				

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Legacy Part Number (before January 3, 2011):

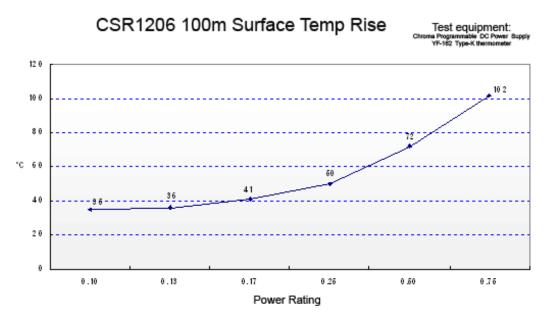
SEI Type			Code		Nominal Resistance	Tolerance		Packagin	g	
CSR			1/2		0.01	1%		R		
Туре	Description	Code	Wattage	Size		Tolerance	SEI Types	Pkg Qty	Description	Code
CSR	Standard	1/8S	0.125W	0402		1%	0402	10,000	7" reel	
CSRN	Narrow Terminations	1/8	0.125W	0603		2%	0603, 0805, 1206	5,000	paper tape	R
		1/4	0.25W	0805		5%	2010, 2512	4,000	7" reel	
		1/2	0.5W	1206			0815, 1225	2,000	plastic tape	
		1S	1W	0815			0402		7" reel	
		1	1W	2010			0603, 0805, 1206	1 000	paper tape	
		2	2W	2512			2010, 2512	1,000	7" reel	1 '
		3	3W	1225			0815, 1225	1	plastic tape	

Resistive Product Solutions

High Power Chip Resistors and Thermal Management

Stackpole has developed several surface mount resistor series in addition to our current sense resistors, which have had higher power ratings than standard resistor chips. This has caused some uncertainty and even confusion by users as to how to reliably use these resistors at the higher power ratings in their designs.

The data sheets for the RHC, RMCP, RNCP, CSR, CSRN, CSRF, CSS, and CSSH state that the rated power assumes an ambient temperature of no more than 100 degrees C for the CSS / CSSH series and 70 degrees C for all other high power resistor series. In addition, IPC and UL best practices dictate that the combined temperature on any resistor due to power dissipated and ambient air shall be no more than 105C. At first glance this wouldn't seem too difficult, however the graph below shows typical heat rise for the CSR 100 milliohm at full rated power. The heat rise for the RMCP and RNCP would be similar. The RHC with its unique materials, design, and processes would have less heat rise and therefore would be easier to implement for any given customer.



The 102 degrees C heat rise shown here would indicate there will be additional thermal reduction techniques needed to keep this part under 105C total hot spot temperature if this part is to be used at 0.75 watts of power. However, this same part at the usual power rating for this size would have a heat rise of around 72 degrees C. This additional heat rise may be dealt with using wider conductor traces, larger solder pads and land patterns under the solder mask, heavier copper in the conductors, vias through PCB, air movement, and heat sinks, among many other techniques. Because of the variety of methods customers can use to lower the effective heat rise of the circuit, resistor manufacturers simply specify power ratings with the limitations on ambient air temperature and total hot spot temperatures and leave the details of how to best accomplish this to the design engineers. Design guidelines for products in various market segments can vary widely so it would be unnecessarily constraining for a resistor manufacturer to recommend the use of any of these methods over another.

Note: The final resistance value can be affected by the board layout and assembly process, especially the size of the mounting pads and the amount of solder used. This is especially notable for resistance values $\leq 50 \text{ m}\Omega$. This should be taken into account when designing.